

## 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

#### PCN# 20231219018.1

Qualification of FFAB using qualified Process Technology, Die Revision and additional Assembly BOM options for select devices

Change Notification / Sample Request

**Date:** December 22, 2023 **To:** PREMIER FARNELL PCN

#### Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments (TI). The details of this change are on the following pages, and are in alignment with our standard product change notification (PCN) <u>process</u>.

TI requires acknowledgement of receipt of this notification within 30 days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 30 days of this notification, given that samples are not built ahead of the change.

The Proposed First Ship date in this PCN letter is the earliest possible date that customers could receive the changed material. It is our commitment that the changed device will not ship before that date. If samples are requested within the 30 day sample request window, customers will still have 30-days to complete their evaluation regardless of the proposed 1st ship date.

This particular PCN is related to TI's multiyear transition plan for our two remaining factories with 150-millimeter production (DFAB in Dallas, Texas, and SFAB in Sherman, Texas). DFAB will remain open, but will focus on 200-mm production, with a smaller set of technologies. SFAB will close no earlier than 2024 and no later than 2025. As referenced in the "reason for change" below, these changes are part of our multiyear plan to transition these products to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the Change Management team. For sample requests or sample related questions, contact your local Field Sales Representative. As always, we thank you for your continued business.

Change Management Team SC Business Services

# 20231219018.1 Attachment: 1

## **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

**DEVICE**OPA2134PA
OPA2134UAE4

**CUSTOMER PART NUMBER** 

null null

Technical details of this Product Change follow on the next page(s).

PCN Num	ber:	2023	3121	9018.1	PCN	Date:		December 22, 2023		
Title:	_			sing qualified Proces	s Techr	nology,	Die Revi	sion and additional		
	Assembly BOI	1 opti	ons	for select devices						
Customer	Contact:		Cha	ange Management t	eam	Dept:		Quality Services		
Proposed 1 <sup>st</sup> Ship Date:			Ма	r 20, 2024	Estim	nated S Availa	ample bility:	Jan 20, 2024*		
*Sample i	*Sample requests received after January 20, 2024 will not be supported.									
Change Type:										
Assemb	ly Site		$\boxtimes$	Design	☐ Wafe		Wafei	Bump Material		
⊠ Assemb	oly Process			Data Sheet			Wafei	Bump Process		
	oly Materials			Part number chang	ge		Wafei	Fab Site		
Mechar	nical Specificati	on		Test Site			Wafei	Fab Materials		
Packing	/Shipping/Labe	ling		Test Process			Wafei	Fab Process		
		•								
				PCN Deta	ils					

# **Description of Change:**

Texas Instruments is pleased to announce the qualification of a new fab & process technology (FFAB, BICOM3XHV) and assembly BOM options for selected devices as listed below in the product affected section.

С	urrent Fab Site	2	Additional Fab Site			
Current Fab Site	Process	Wafer Diameter	Additional Fab Site	Process	Wafer Diameter	
SFAB	BIPOLAR	150 mm	FFAB	BICOM3XHV	200 mm	

The die was also changed as a result of the process change.

Assembly BOM options are noted below:

## **Group 1 Device:**

	Current	Proposed
Wire composition, diam	Au, 1.15mil	Cu, 0.96mil
Die Coat	4221706	None

# **Group 2 Device:**

	Current	Proposed
Wire composition, diam	Au, 1.15mil	Au, 0.96mil

Qual details are provided in the Qual Data Section.

## Reason for Change:

These changes are part of our multiyear plan to transition products from our 150-millimeter factories to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity.

# Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

#### **Impact on Environmental Ratings:**

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
☑ No Change	☑ No Change	☑ No Change	☑ No Change

## Changes to product identification resulting from this PCN:

## **Fab Site Information:**

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
SH-BIP-1	SHE	USA	Sherman
FR-BIP-1	TID	DEU	Freising

#### Die Rev:

 Current
 New

 Die Rev [2P]
 Die Rev [2P]

 A
 B

Sample product shipping label (not actual product label)

TEXAS INSTRUMENTS
MADE IN: Malaysia 2DC: 20:
MSL 2 /260C/1 YEAR SEAL DT

2DC: 2Q:

MSL '2 /260C/1 YEAR SEAL DT

MSL 1 /235C/UNLIM 03/29/04

OPT:
ITEM: 39

(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T) LOT: 3959047MLA (4W) TKY(1T) 7523483\$I2 (P) (2P) REV: (V) 0033317 (201) CSO: SHE (211) CCO: USA (22L) ASO: MLA (23L) ACO: MYS

**Group 1 Product Affected:** 

OPA2134UA	OPA2134UA/2K5E4	OPA2134UAG4
OPA2134UA/2K5	OPA2134UAE4	

# **Group 2 Product Affected:**

OPA134UA	OPA4134UA	OPA4134UAE4
OPA134UA/2K5	OPA4134UA/2K5	
OPA134UAE4	OPA4134UA/2K5E4	

For alternate parts with similar or improved performance, please visit the product page on TI.com

### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>OPA134UA</u>	QBS Process Reference: OPA202ID	QBS Process Reference: <u>OPA1662AIDGKRQ1</u>	QBS Package Reference: OPA2810IDR	QBS Package Process Reference: THP210DR	QBS Package Reference: <u>OPA4991QDRQ1</u>
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	3/231/0	-	3/231/0	3/231/0	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	-	-	-	3/231/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	-	3/231/0	-	3/231/0	3/231/0	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	3/231/0	3/231/0	3/231/0	-	1/77/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	3/231/0	-	-	-	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	-	3/231/0	3/231/0	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	-	-	-	-	1/45/0
HTOL	B1	Life Test	150C	300 Hours	-	3/231/0	-	-	-	-
HTOL	B1	Life Test	150C	408 Hours	-	-	-	-	-	1/77/0
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	-	3/2400/0	-	-	-
ESD	E2	ESD CDM	-	500 Volts	1/3/0	3/9/0	-	1/3/0	-	1/3/0

Туре	#	Test Name	Condition	Duration	Qual Device: <u>OPA134UA</u>	QBS Process Reference: <u>OPA202ID</u>	QBS Process Reference: <u>OPA1662AIDGKRQ1</u>	QBS Package Reference: <u>OPA2810IDR</u>	QBS Package Process Reference: THP210DR	QBS Package Reference: <u>OPA4991QDRQ1</u>
ESD	E2	ESD HBM	-	2000 Volts	1/3/0	3/9/0	-	1/3/0	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	1/3/0	-	1/6/0	-	1/6/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	3/90/0	1/30/0	-	-	-

- QBS: Qual By Similarity
- Qual Device OPA134UA is qualified at MSL1 260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2107-013

#### **Qualification Results**

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Type # Test Name Condi	me Condition Durati		Qual Device: OPA4134UA	QBS Product Reference:	QBS Process Reference:	QBS Process Reference:	QBS Package Reference:	QBS Package Reference:	QBS Package Reference:	
					<u>UFA4134UA</u>	OPA134UA	INA828ID	OPA1662AIDGKRQ1	OPA4187ID	OPA4202ID	OPA1644AID
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0	-	3/231/0	-	-
UHAST	А3	Autoclave	121C/15psig	96 Hours	-	-	-	-	-	-	1/77/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	-	-	3/231/0	-	3/231/0	1/77/0	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-	3/231/0	1/77/0	1/77/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/231/0	-	-	-	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	-	-	3/231/0	-	-
HTOL	B1	Life Test	125C	1000 Hours	-	-	3/231/0	-	-	-	-
HTOL	B1	Life Test	140C	300 Hours	-	-	-	-	-	1/77/0	-

Туре	#	Test Name	Condition	Duration	Qual Device: <u>OPA4134UA</u>	QBS Product Reference:	QBS Process Reference:	QBS Process Reference: OPA1662AIDGKRQ1	QBS Package Reference:	QBS Package Reference:	QBS Package Reference:
						OPA134UA	INA828ID	377120027110 3111142	<u>OPA4187ID</u>	OPA4202ID	OPA1644AID
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	-	-	3/2400/0	-	-	-
ESD	E2	ESD CDM	-	1000 Volts	-	-	-	-	-	-	1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	1/3/0	-	1/3/0	1/3/0	-
ESD	E2	ESD HBM	-	1000 Volts	-	1/3/0	1/3/0	-	1/3/0	1/3/0	-
ESD	E2	ESD HBM	-	2000 Volts	-	1/3/0	1/3/0	-	-	1/3/0	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	1/3/0	1/6/0	-	1/6/0	1/6/0	1/6/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	-	1/30/0	3/90/0	-	1/30/0	1/30/0	1/30/0
FTY	E6	Final Test Yield	-	-	1/Pass	-	-	-	-	-	-

- · QBS: Qual By Similarity
- Qual Device OPA4134UA is qualified at MSL2 260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2107-019

#### **Qualification Results**

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: OPA2134UA	QBS Product Reference:	QBS Process Reference:	QBS Packege Reference:	QBS Package Reference:
						517110 127115	OPA202ID	OPA2810IDR	OPA862IDR
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0	3/231/0	1/77/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	-	1/77/0	3/231/0	3/231/0	1/77/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	1/77/0	3/231/0	3/231/0	1/77/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/231/0	-	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	-	3/231/0	1/77/0
HTOL	B1	Life Test	150C	300 Hours	-	-	3/231/0	-	3/231/0
ESD	E2	ESD CDM	-	250 Volts	-	1/3/0	3/9/0	1/3/0	1/3/0
ESD	E2	ESD CDM	-	500 Volts	1/3/0				
ESD	E2	ESD HBM	-	1000 Volts	-	1/3/0	3/9/0	1/3/0	1/3/0
ESD	E2	ESD HBM	-	2000 Volts	-	1/3/0	-	-	-
LU	E4	Latch-Up	Per JESD78	-	1/3/0	1/3/0	1/3/0	1/6/0	1/3/0

Туре	#	Test Name	Condition	Duration	Qual Device: OPA2134UA	QBS Product Reference: OPA1642AID	QBS Process Reference: <u>OPA202ID</u>	QBS Packege Reference: OPA2810IDR	QBS Package Reference: <u>OPA862IDR</u>
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	-	1/30/0	3/90/0	1/30/0	3/90/0
FTY	E6	Final Test Yield	-	-	1/Pass	-	-	-	-

- QBS: Qual By Similarity
- Qual Device OPA2134UA is qualified at MSL2 260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2107-018

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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